TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

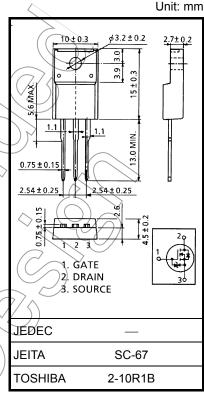
2SK3543

Switching Regulator and DC-DC Converter Applications Motor Drive Applications

- Low drain-source ON resistance: $R_{DS (ON)} = 1.9 \Omega (typ.)$
- High forward transfer admittance: |Y_{fs}| = 1.3 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 450 V)
- Enhancement-model: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_{D} = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit
Drain-source voltage			V_{DSS}	450	A
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			V_{DGR}	450	y
Gate-source voltage			V_{GSS}	±30	> v
Drain current	DC	(Note 1)	I _D	2	Α
	Pulse	(Note 1)	I_{DP}	5	
Drain power dissipation (Tc = 25°C)			P _D <	30	W
Single pulse avalanche energy (Note 2)			EAS	103	, mg
Avalanche current			IAR	2	Α
Repetitive avalanche energy (Note 3)			(EAR	3	mJ
Channel temperature			Tch	150	7,¢
Storage temperature range			∑/√ _{stg}	-55 to 150	√ °C



Weight: 1.9 g (typ.)

Note: Using continuously under neavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	4.17	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

- Note 1: Please use devices on condition that the channel temperature is below 150°C.
- Note 2: $V_{DD} = 90~V$, $T_{ch} = 25^{\circ}C$ (initial), L = 42.8~mH, $R_G = 25~\Omega$, $I_{AR} = 2~A$
- Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

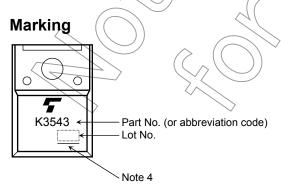
This transistor is an electrostatic sensitive device. Please handle with caution.

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Drain-source brea	rain-source breakdown voltage		$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30			V
Drain cut-OFF cu	rain cut-OFF current		V _{DS} = 450 V, V _{GS} = 0 V	/	_	100	μΑ
Drain-source brea	Orain-source breakdown voltage		$I_D = 10$ mA, $V_{GS} = 0$ V	450	_	_	V
Gate threshold vo	Gate threshold voltage		V _{DS} = 10 V, I _D = 1 mA	2.0) >-	4.0	V
Drain-source ON	ain-source ON resistance		V _{GS} = 10 V, I _D = 1 A	\rightarrow	1.9	2.45	Ω
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 1 A	0.6	1.3	_	S
Input capacitance		C _{iss}			380	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	40	_	pF
Output capacitance		C _{oss}		_	120		
Switching time	Rise time	t _r	V _{GS} I _D 1A V _{OUT}		15/	/	
	Turn-ON time	t _{on}	0 V	_((25) —	20
	Fall time	tf		7	> 20		ns
	Turn-OFF time	t _{off}	Duty \leq 1%, $t_W = 10 \mu s$ $V_{DD} \simeq 200 \text{ V}$		80		
Total gate charge (gate-source plus gate-drain)		Qg) _	9		
Gate-source charge		Q _{gs}	$V_{DD} \simeq 360 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$	_	5	_	nC
Gate-drain ("miller") charge		Qgd		_	4	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	(7)\\ -	_	_	2	Α
Pulse drain reverse current (Note 1)	I _{DRP}	(V) -	_	_	5	Α
Forward voltage (diode)	VDSF	$1_{DR} = 2 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.5	V
Reverse recovery time	tir	$I_{DR} = 2 \text{ A}, V_{GS} = 0 \text{ V},$	_	1000	_	ns
Reverse recovery charge	Qrr	dl _{DR} /dt = 100 A/μs	_	3.5	_	μС

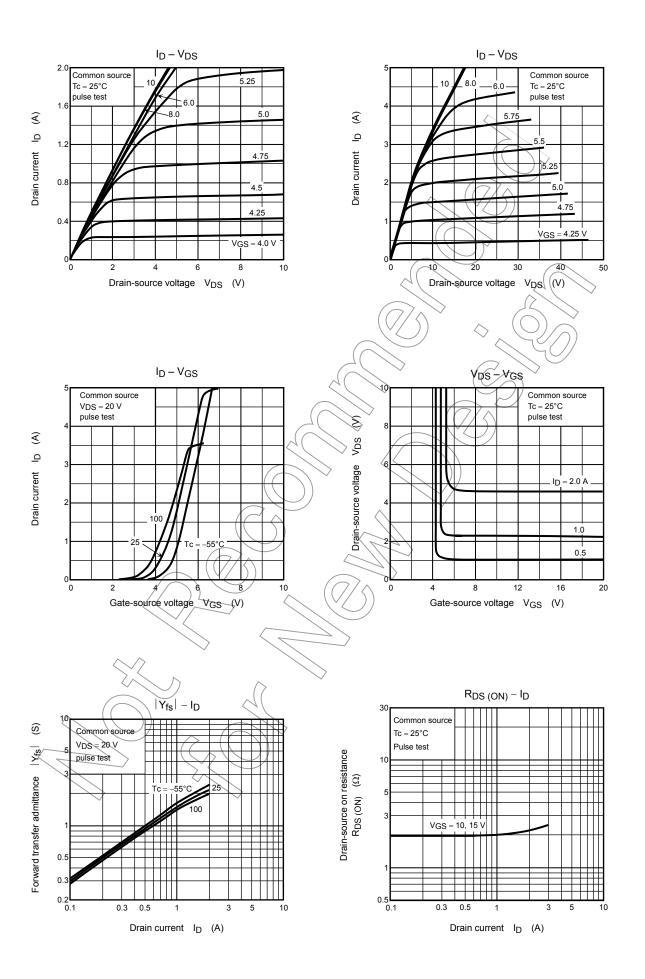


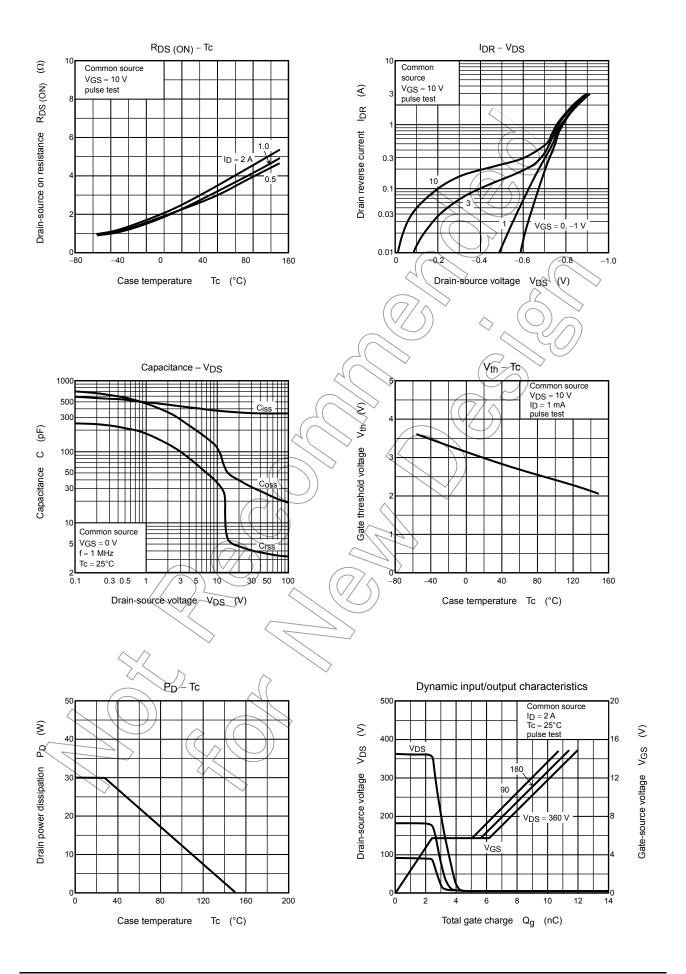
Note 4: A line under a Lot No. identifies the indication of product Labels.

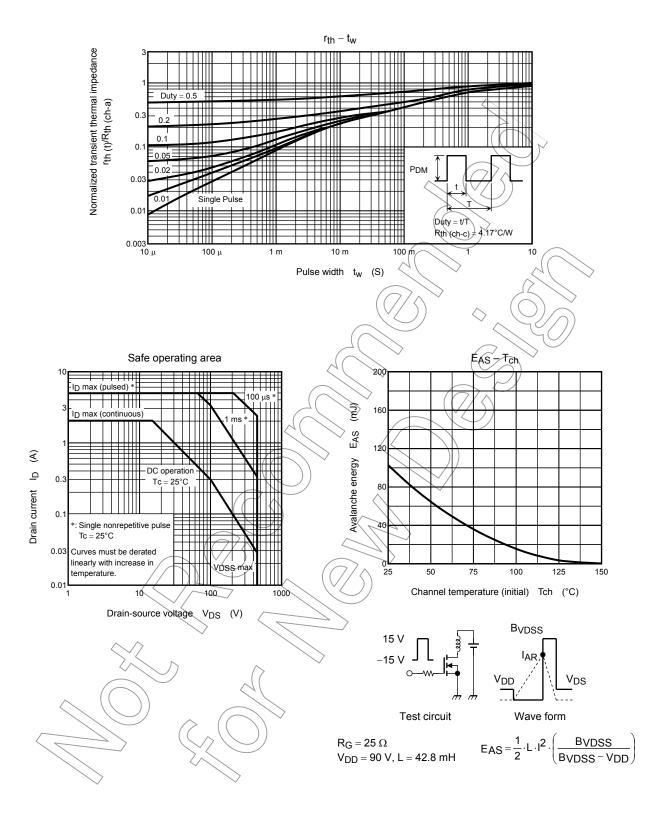
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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